

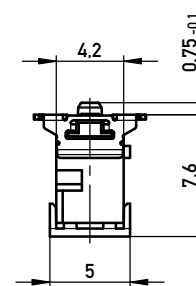
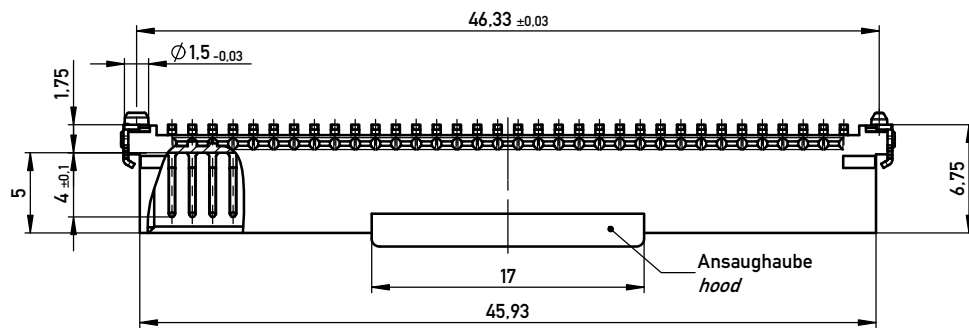
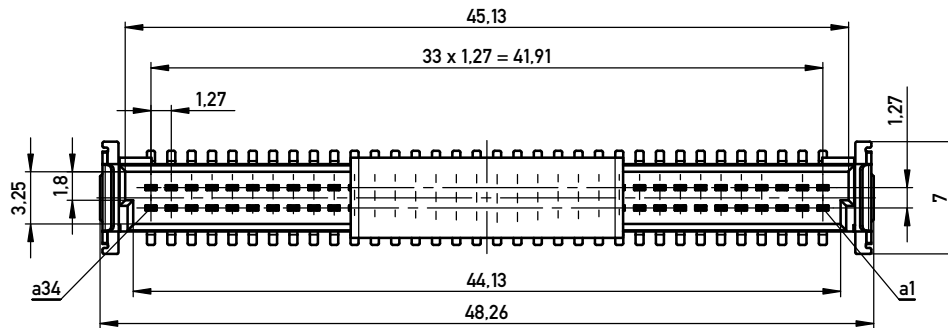
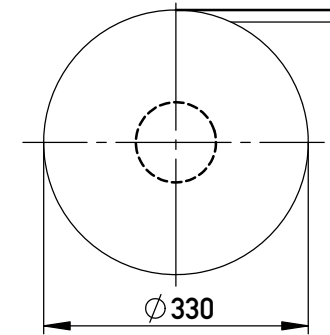
Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

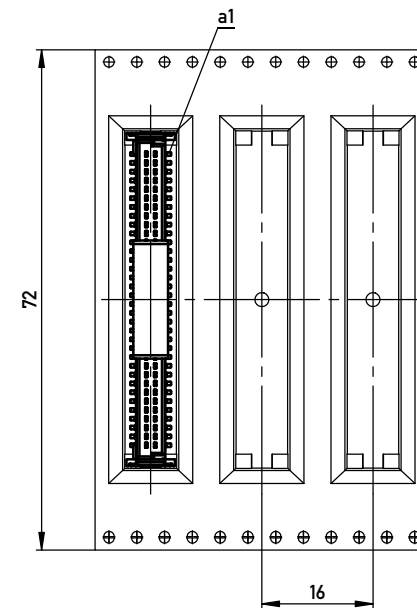
Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm
Coplanarity Area of Termination ≤ 0,1 mm

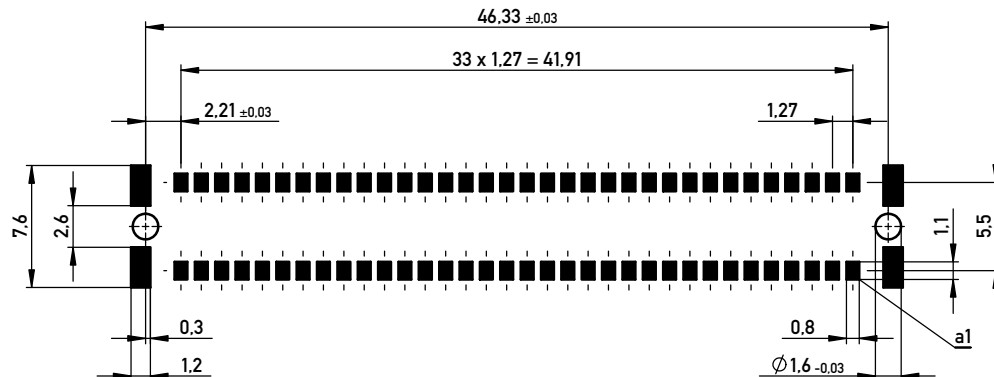
Verpackt in Gurtverpackung
Tape on Reel Packaging
Verpackungseinheit: 280 Stück
Packaging unit: 280 pcs



Abspulrichtung - Reel off Direction



Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



BA 8-13 - 8mm Bauhöhe
type 8-13 - Low Profile

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Information:			Tolerances		 All Dimensions in mm		Scale 3:1			
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						Messerl. SMC-Q 68-SMD-BA8-13 <i>Male SMC-Q 68-SMD-type8-13</i>				
						244839				
d		23.07.2013				www.ERNI.com				I
Index		Date						Class		SMCQ
										A3

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